

MPXV1D0830L220 Aliases (UPI2X10830V220) KEMET, MPXV, Metal Composite, 20%, 22 uH, 0830(3431)

8.65 ± 0.25 3.0 Maximum (1.3) (1.3) (1.3) (1.3) (1.3) (1.3) (1.3) (1.3) (1.3) (1.3) (1.3) (1.3)

| General Information | |
|---------------------|------------------------------|
| Series | MPXV |
| Style | SMD Molded |
| Core | Metal Composite |
| Description | Surface Mount Inductor |
| Features | Power Inductors |
| RoHS | Yes |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Miscellaneous | 40 (K) Temperature Rise Max. |

Click here for the 3D model.

| Dimensions | |
|------------|------------------|
| Chip Size | 0830(3431) |
| L | 8.65mm +/-0.25mm |
| W | 8mm +/-0.2mm |
| т | 3mm MAX |
| G | 5.1mm +/-0.3mm |

1.07 g

1500

T&R, 330mm

Packaging Specifications

Typical Component Weight
Packaging
Packaging Quantity

| Specifications | |
|-------------------------|--|
| Inductance | 22 uH (100 kHz) |
| Inductance Tolerance | 20% |
| Rated Current | 3.6 A (Irms, 40C Rise By Self Heating) |
| Saturation Current | 3.5 A (Isat, 20% Drop In Inductance), 5 A (Isat, 30% Drop In Inductance) |
| Temperature Range | -55/+155°C |
| Shielded | Yes |
| DC Resistance | 134.5 mOhms |
| DC Resistance | 134.5 mOhms |
| Self-Resonant Frequency | 8.1 MHz |

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